

Electronic Acknowledgement Receipt

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Application Number:	10663967
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Title of Invention:	Methods of fabricating integrated circuit devices having fuse structures including buffer layers
First Named Inventor:	Hyun-Chul Kim
Customer Number:	20792
Filer:	Elizabeth A. Stanek/Erin Campion
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		5649-1161_Amendment.pdf	331692	yes	9

	Multipart Description		
	Doc Desc	Start	End
	Amendment After Final	1	1
	Claims	2	6
	Applicant Arguments/Remarks Made in an Amendment	7	9
Warnings:			
Information:			
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